



SURFACE MOUNT SUPER FAST RECOVERY RECTIFIER

Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low reverse leakage
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:
- ◆ 250°C/10 seconds at terminals
- Glass passivated chip junction

DO-214AC/SMA

**Mechanical Data**

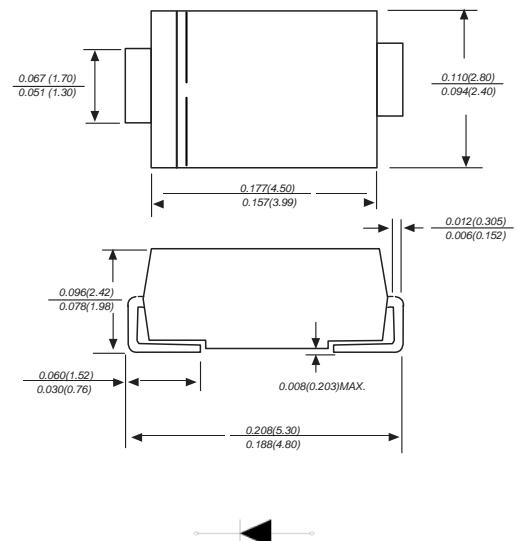
Case : JEDEC DO-214AC/SMA Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0019 ounce, 0.055grams



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	MDD ES2A	MDD ES2B	MDD ES2C	MDD ES2D	MDD ES2E	MDD ES2G	MDD ES2J	UNITS				
Marking Code													
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	600	V				
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V				
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	V				
Maximum average forward rectified current at T _c =125°C	I _(AV)	2.0						A					
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	50						A					
Maximum instantaneous forward voltage at 2.0A	V _F	1		1.25		1.68		V					
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C	I _R	5.0 100.0						uA					
Maximum reverse recovery time (NOTE 1)	t _{rr}	35						ns					
Typical junction capacitance (NOTE 2)	C _J	40.0						pF					
Typical thermal resistance (NOTE 3)	R _{θJA}	60.0						°C/W					
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150						°C					

Note: 1. Reverse recovery condition I_F=0.5A, I_R=1.0A, I_{rr}=0.25A

2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

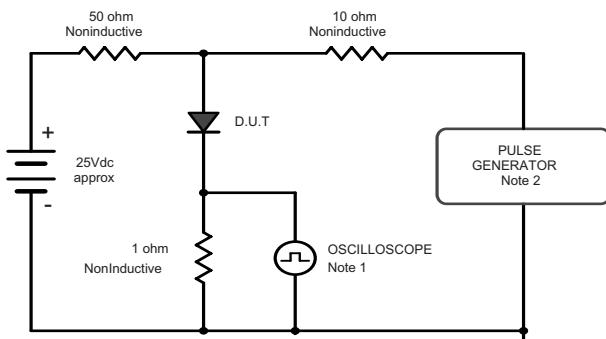
3. Pulse test: Pulse width 200 sec, Duty cycle 2%

4. P.C.B. mounted with 1.0 X 1.0" (2.54 X 2.54 cm) copper pad areas.



Ratings And Characteristic Curves

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm,22pF.
2. Ries Time =10ns, max.
Source Impedance = 50 ohms.

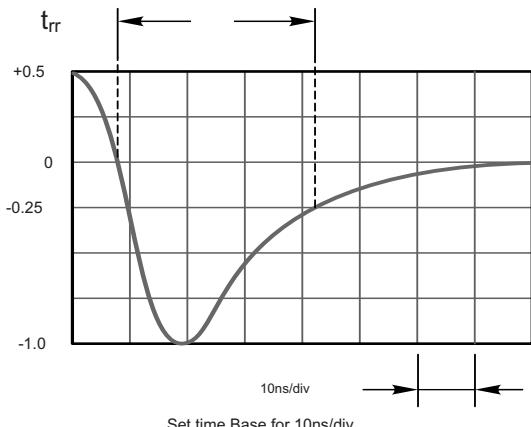


Fig.2 Maximum Average Forward Current Rating

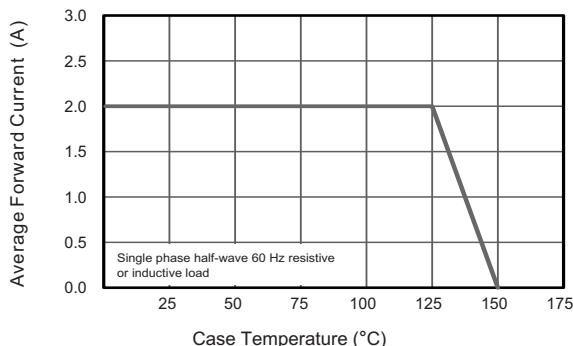


Fig.4 Typical Forward Characteristics

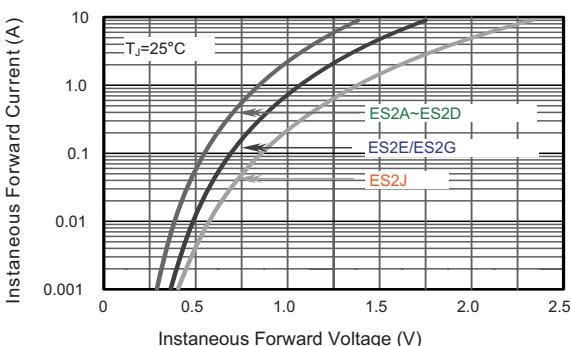
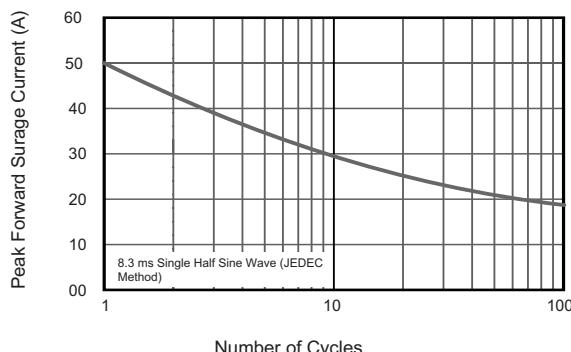


Fig.6 Maximum Non-Repetitive Peak Forward Surge Current



The curve above is for reference only.

Fig.3 Typical Reverse Characteristics

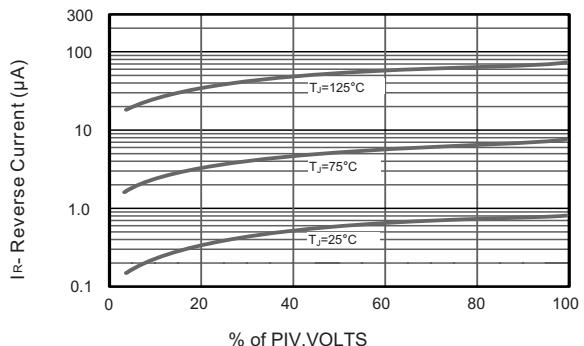
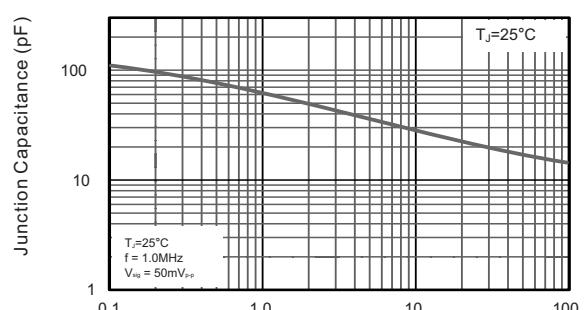
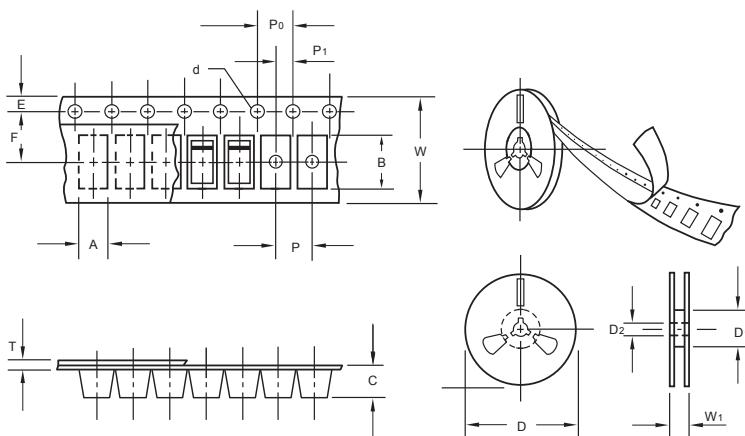


Fig.5 Typical Junction Capacitance



Packing information



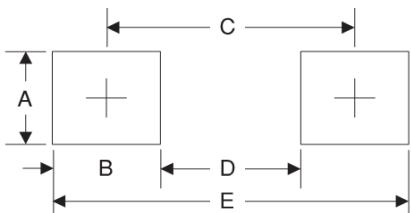
Item	Symbol	Tolerance	SMA
Carrier width	A	0.1	2.80
Carrier length	B	0.1	5.33
Carrier depth	C	0.1	2.36
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D ₁	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D ₁	min	62.00
Feed hole diameter	D ₂	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P ₀	0.1	4.00
Embossment center	P ₁	0.1	2.00
Overall tape thickness	T	0.1	0.28
Tape width	W	0.3	12.00
Reel width	W ₁	1.0	18.00

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMA	7"	2,000	4.0	4,000	183*155*183	178	382*356*392	80,000	16.0
SMA	11"	5,000	4.0	10,000	290*290*38	330	310*310*360	80,000	11.0
SMA	13"	7,500	4.0	15,000	335*335*38	330	350*330*360	120,000	14.5

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
B	1.52	0.060
C	3.90	0.154
D	2.41	0.095
E	5.45	0.215

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